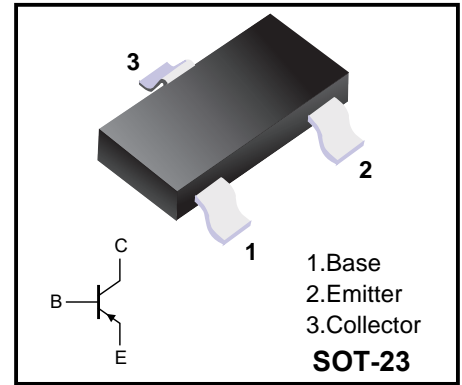


**PNP Silicon Epitaxial Planar Transistor**



<b>Marking Code</b>	
<b>PBSS5350T</b>	<b>ZD</b>

**FEATURES**

- ◆ Low collector-emitter saturation voltage  $V_{CEsat}$
- ◆ High collector current capability:  $I_C$  and  $I_{CM}$
- ◆ Higher efficiency leading to less heat generation
- ◆ Reduced printed-circuit board requirements.
- ◆ Case: SOT-23

**APPLICATIONS**

- ◆ Power management
  - DC/DC converters
  - Supply line switching
  - Battery charger
  - LCD backlighting.

**Limiting Values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Parameters	Conditions	Symbol	Value	Unit
collector-base voltage	open emitter	$V_{CBO}$	-50	V
collector-emitter voltage	open base	$V_{CEO}$	-50	V
emitter-base voltage	open collector	$V_{EBO}$	-5	V
collector current (DC)	note 4	$I_C$	-3	A
peak collector current	limited by $T_{j(max)}$	$I_{CM}$	-5	A
base current (DC)		$I_B$	-0.5	A
total power dissipation	$T_{amb} \leq 25\text{ °C}$	$P_{tot}$	300	mW
	note 1			
	note 2			
	note 3			
	note 4		600	mW
storage temperature		$T_{STG}$	-65+150	°C
junction temperature		$T_J$	150	°C
ambient temperature		$T_{amb}$	-65 +150	°C

Notes

1. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; standard footprint.
2. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; mounting pad for collector 1 cm<sup>2</sup>.
3. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; mounting pad for collector 6 cm<sup>2</sup>.
4. Device mounted on a ceramic printed-circuit board 7 cm<sup>2</sup>, single-sided copper, tin-plated.

**Characteristics**

Tamb = 25 °C unless otherwise specified.

Parameter	Test Condition	Symbol	Min	Typ	Max	Unit
collector-base cut-off current	$V_{CB} = -50\text{ V}; I_E = 0\text{ A}$	$I_{CBO}$	-	-	-100	nA
	$V_{CB} = -50\text{ V}; I_E = 0\text{ A}; T_J = 150\text{ °C}$		-	-	-50	μA
collector-emitter cut-off current	$V_{CE} = -50\text{ V}; V_{BE} = 0\text{ V}$	$I_{CES}$	-	-	-100	nA
emitter-base cut-off current	$V_{EB} = -5\text{ V}; I_C = 0\text{ A}$	$I_{EBO}$	-	-	-100	nA
DC current gain	$V_{CE} = -2\text{ V}$	$h_{FE}$				
	$I_C = -0.1\text{ A}$		200	-	-	
	$I_C = -0.5\text{ A}$		200	-	-	
	$I_C = -1\text{ A}; \text{note 1}$		200	-	-	
	$I_C = -2\text{ A}; \text{note 1}$		130	-	-	
	$I_C = -3\text{ A}; \text{note 1}$		80	-	-	
collector-emitter saturation voltage	$I_C = -0.5\text{ A}; I_B = -50\text{ mA}$	$V_{CEsat}$	-	-	-90	mV
	$I_C = -1\text{ A}; I_B = -50\text{ mA}$		-	-	-180	mV
	$I_C = -2\text{ A}; I_B = -100\text{ mA}$		-	-	-320	mV
	$I_C = -2\text{ A}; I_B = -200\text{ mA}; \text{note 1}$		-	-	-270	mV
	$I_C = -3\text{ A}; I_B = -300\text{ mA}; \text{note 1}$		-	-	-390	mV
equivalent on-resistance	$I_C = -2\text{ A}; I_B = -200\text{ mA}; \text{note 1}$	$R_{CEsat}$	-	-	135	mΩ
base-emitter saturation voltage	$I_C = -2\text{ A}; I_B = -100\text{ mA}$	$V_{BEsat}$	-	-	-1.1	V
	$I_C = -3\text{ A}; I_B = -300\text{ mA}; \text{note 1}$		-	-	-1.2	V
base-emitter turn-on voltage	$V_{CE} = -2\text{ V}; I_C = -1\text{ A}$	$V_{BEon}$	-	-	-1.2	V
transition frequency	$I_C = -100\text{ mA}; V_{CE} = -5\text{ V}; f = 100\text{ MHz}$	$f_T$	100	-	-	MHz
collector capacitance	$V_{CB} = -10\text{ V}; I_E = I_C = 0\text{ A}; f = 1\text{ MHz}$	$C_c$	-	-	35	pF

**Note 1. Pulse test:  $t_p \leq 300\text{ }\mu\text{s}; \delta \leq 0.02.$**

**Electrical Characteristic Curve**

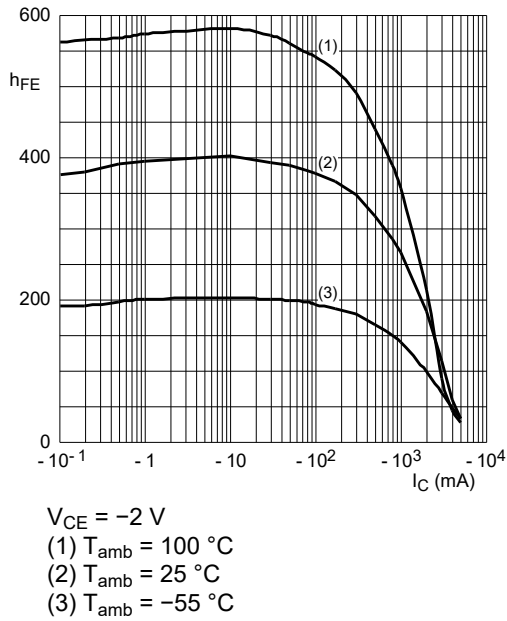


Fig.1 DC current gain as a function of collector current; typical values.

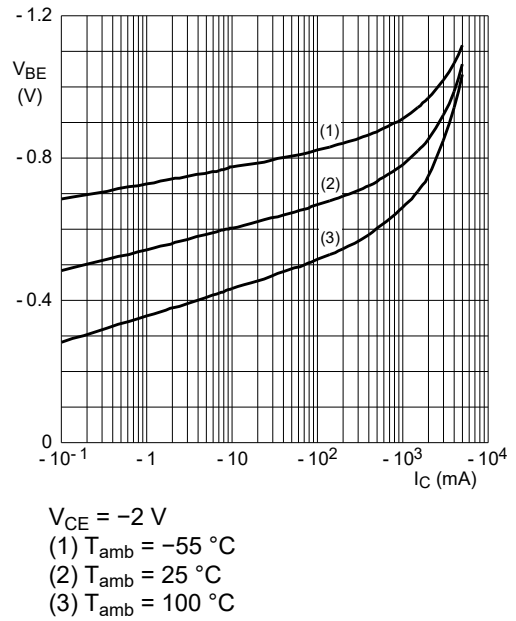


Fig.2 Base-emitter voltage as a function of collector current; typical values.

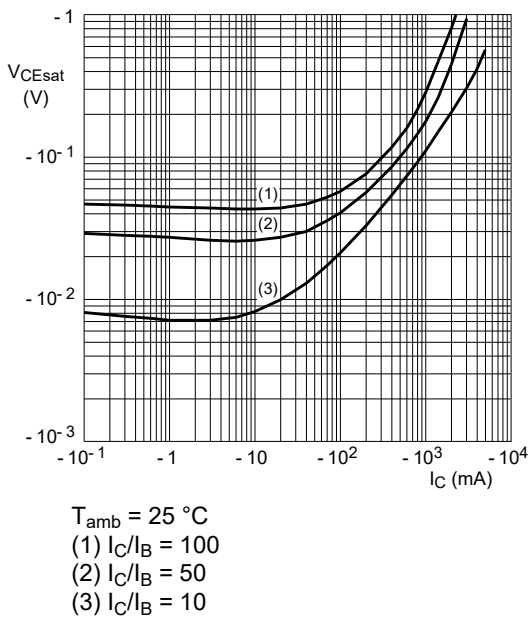


Fig.3 Collector-emitter saturation voltage as a function of collector current; typical values.

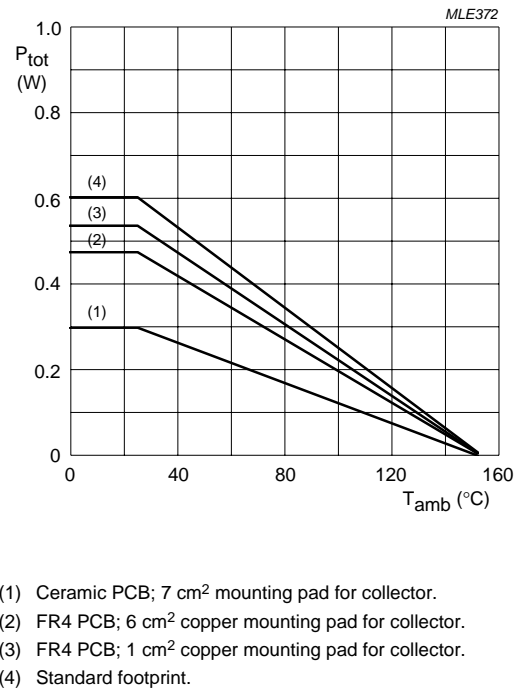


Fig.4 Power derating curves.

**Ordering information**

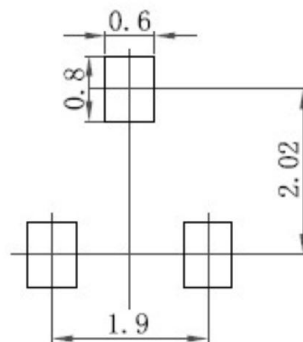
Package	Packing Description	Base Quantity	Packing Quantity
SOT-23	Tape/Reel,7"reel	3000pcs/Reel	24000PCS/Box 120000PCS/Carton

**Package Dimensions**

**SOT-23**

Dim.	Millimeter (mm)		mil	
	Min.	Max.	Min.	Max.
A	0.9	1.15	35	45
A1	0.1		3.9	
bp	0.38	0.48	15	19
C	0.09	0.15	3.54	5.9
D	2.8	3.0	110	118
E	1.2	1.4	47	55
e	1.9		75	
e1	0.95		37	
HE	2.1	2.55	83	100
Lp	0.15	0.45	5.9	18
Q	0.45	0.55	18	22
v	0.2		7.9	
W	0.1		4	

**The recommended mounting pad size**



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